

Schottky Barrier Diode Silicon Epitaxial

# **CUS05F40**

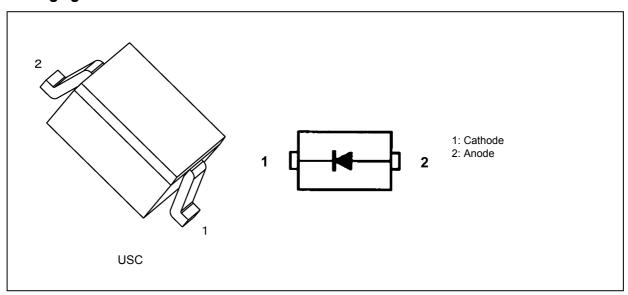
#### 1. Applications

· High-Speed Switching

#### 2. Features

- (1) High average rectified current
- (2) Low Reverse current:  $I_R(2) = 1.8 \mu A$  (typ.) at  $V_R = 40 \text{ V}$

#### 3. Packaging and Internal Circuit



# 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

| Characteristics                           | Symbol           | Note     | Rating     | Unit |
|---|------------------|----------|------------|------|
| Reverse voltage                           | V <sub>R</sub>   |          | 40         | V    |
| Average rectified current                 | I <sub>O</sub>   | (Note 1) | 0.5        | Α    |
| Non-repetitive peak forward surge current | I <sub>FSM</sub> | (Note 2) | 5          | Α    |
| Junction temperature                      | Tj               |          | 150        | °C   |
| Storage temperature                       | T <sub>stg</sub> |          | -55 to 150 | °C   |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 645 \text{ mm}^2)$ 

Note 2: Measured with a 10 ms pulse.

Start of commercial production

2016-06



# 5. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

| Characteristics   | Symbol             | Test Condition                  | Min | Тур. | Max  | Unit |
|-------------------|--------------------|---------------------------------|-----|------|------|------|
| Forward voltage   | V <sub>F</sub> (1) | I <sub>F</sub> = 100 mA         | _   | 0.40 | 0.45 | V    |
|                   | V <sub>F</sub> (2) | I <sub>F</sub> = 500 mA         | _   | 0.74 | 0.81 |      |
| Reverse current   | I <sub>R</sub> (1) | V <sub>R</sub> = 10 V           | _   | 1.0  | 10   | μА   |
|                   | I <sub>R</sub> (2) | V <sub>R</sub> = 40 V           | _   | 1.8  | 15   |      |
| Total capacitance | Ct                 | V <sub>R</sub> = 0 V, f = 1 MHz | _   | 28   |      | pF   |

### 6. Marking

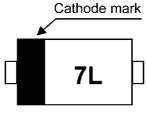


Fig. 6.1 Marking

| Marking Code | Part Number |  |  |
|--------------|-------------|--|--|
| 7L           | CUS05F40    |  |  |

#### 7. Usage Considerations

• Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

## 8. Land Pattern Dimensions (for reference only)

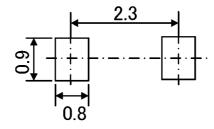


Fig. 8.1 Land Pattern Dimensions for Reference Only (Unit: mm)



# 9. Characteristics Curves (Note)

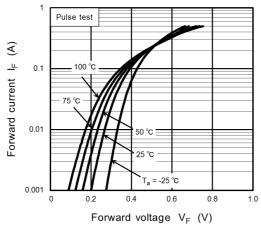


Fig. 9.1  $I_F - V_F$  Fig. 9.2  $I_R - V_R$ 

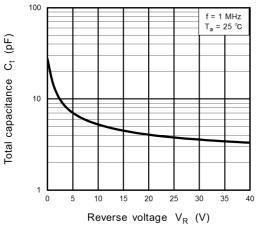


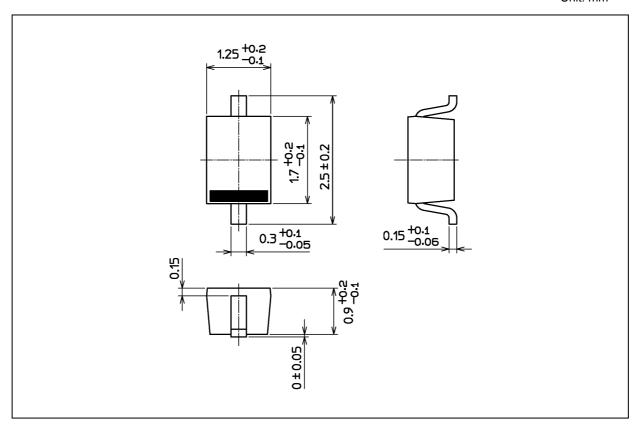
Fig. 9.3  $C_t - V_R$ 

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# **Package Dimensions**

Unit: mm



Weight: 4.5 mg (typ.)

|                 | Package Name(s) |
|-----------------|-----------------|
| TOSHIBA: 1-1E1S |                 |
| Nickname: USC   |                 |



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